



#### **Model RFP-100NXXAF**

# Flanged Resistors 100 Watts, $50\Omega$



### General Specifications

Resistive Element Thick film

Substrate Aluminum nitride ceramic

Cover Alumina ceramic

**Leads** 99% pure silver (.005" thick)

#### Features:

- DC see chart
- 100 Watts
- Aluminum Nitride Ceramic
- Non-Nichrome Resistive Element
- Welded Silver Leads
- Low VSWR
- 100% Tested

#### **Electrical Specifications**

**Attenuation Range:** 1, 2, 3, 4, 5, 6, 9, 10, 20, 30 db

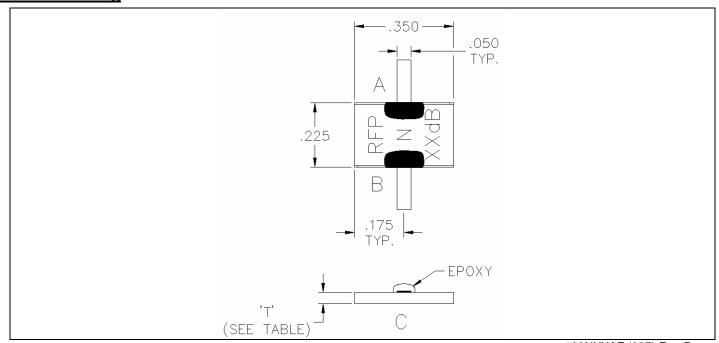
Frequency Range; DC – see chart
Power: 100 Watts
VSWR: 1.25:1

Tolerance is  $\pm 0.010$ ", unless otherwise specified. Designed to meet of exceed applicable portions of MIL-E-5400. Operating temperature is -55 $^{\circ}$ C to 150 $^{\circ}$ C (see chart for derating temperatures).

All dimensions in inches.

Specifications subject to change with out notice.

#### **Outline Drawing**



100NXXAF (097) Rev B





Available on Tape and Reel For Pick and Place Manufacturing.

USA/Canada: (315) 432-8909 Toll Free: (800) 544-2414 Europe: +44 2392-232392

## **Model RFP-100NXXAF**



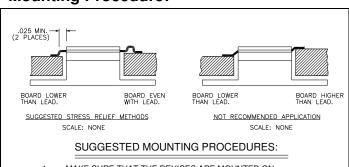
#### **Specifications:**



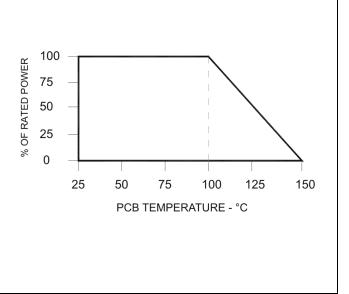
_				<u> </u>			
RESISTOR VALUE CHART							
ATTENUATION	VALUE (A-B)	VALUE (A-C)	VALUE (B-C)	TOL.	FREQUENCY	R.F.P. STOCK P/N	THICKNESS
1dB±0.25dB	4.8Ω	435 Ω	435 Ω	±4%	DC-2.2GHz.	RFP-100N1AF	.060
1.5dB±0.30dB	7.4 Ω	294 Ω	294 Ω	±4%	DC-2.2GHz.	RFP-100N1R5AF	.060
2dB±0.40dB	9.6Ω	232 ∩	232 ∩	±4%	DC-2.2GHz.	RFP-100N2AF	.060
3dB±0.40dB	15.2Ω	155 Ω	155 Ω	±4%	DC-2.5GHz.	RFP-100N3AF	.060
4dB±0.40dB	22Ω	151Ω	151Ω	±4%	DC-2.5GHz.	RFP-100N4AF	.060
5dB±0.40dB	28.5Ω	94.7Ω	94.7Ω	±4%	DC-3.0GHz.	RFP-100N5AF	.060
6dB±0.40dB	33.7Ω	82.5 <b>∩</b>	82.5 🗘	±4%	DC-3.0GHz.	RFP-100N6AF	.060
9dB±0.75dB	50.6Ω	64.1Ω	63.3Ω	±4%	DC-2.2GHz.	RFP-100N9AF	.060
10dB±0.75dB	54.0Ω	59.8Ω	59.8Ω	±4%	DC-2.2GHz.	RFP-100N10AF	.060
20dB±0.50dB	248Ω	61.0 Ω	61.0 Ω	±4%	DC-2.0GHz.	RFP-100N20AF	.040
30dB±0.50dB	790Ω	53.0 Ω	53.0 Ω	±4%	DC-2.5GHz.	RFP-100N30AF	.040

#### **Mounting Procedure:**

#### Power derating:



- MAKE SURE THAT THE DEVICES ARE MOUNTED ON FLAT SURFACES (.001" UNDER THE DEVICE) TO OPTIMIZE THE HEAT TRANSFER.
- 2. POSITION DEVICE ON MOUNTING SURFACE AND SOLDER IN PLACE USING AN APPROPRIATE TYPE SOLDER.
- 3. SOLDER LEADS IN PLACE USING AN APPROPPRIATE TYPE SOLDER WITH A CONTROLLED TEMPERATURE IRON. KEEP LEAD LENGTH AS SHORT AS POSSIBLE USING A SUGGESTED STRESS RELIEF METHOD.



100NXXAF (097) Rev B

USA/Canada: Toll Free: Europe: (315) 432-8909 (800) 544-2414 +44 2392-232392 Available on Tape and Reel For Pick and Place Manufacturing.



